



Product Overview

Electrically conductive foil tape is manufactured by applying a conductive adhesive to one or both surfaces of a metal foil such as copper or aluminium. This is then either self wound or has a separate release liner applied. This is then slit to standard or custom widths.

Applications

- Temporary sealing of gaps for EMC testing
- PCB shields
- Cable shields
- Shielded room seams

Availability

Normally supplied in 33 metre rolls, in standard widths of 13mm & 25mm. However any width from 8mm up to approx 200mm, and 50 metre rolls can be supplied to special order. We can also supply with non-conductive adhesive or without adhesive if required, to special order.

Tapes can be supplied in two versions – Self Wound, without a release liner, or with a paper release liner. Versions having the paper release liner have a suffix -6 added to the part number.

Example

9115-6 = Copper Tape with conductive adhesive & release liner
9115 = Copper Tape without release liner

- Die cut parts
- Kiss cut parts.

Design Considerations

- Consider if it is a temporary or permanent solution
- Galvanic compatibility
- Adhesive strength

Production Capabilities

- Die cutting
- Slitting
- Laminating

Material	Part No.
Aluminium Tape with Conductive Adhesive for EMI Shielding	9015
Copper Tape with Non-Conductive Adhesive	9110
Copper Tape with Conductive Adhesive for EMI Shielding, Solderable	9115
Copper Tape with Conductive Adhesive on both sides for EMI Shielding	9116
Tin-clad Copper Tape with Non-Conductive Adhesive, Solderable	9510
Tin-clad Copper Tape with Conductive Adhesive, Solderable	9515

Material 9015: Aluminium Tape with Conductive Adhesive for EMI Shielding

Stocked in 25mm widths

Base thickness	0.040mm
Total thickness	0.065mm
Adhesive strength	4.5 N/cm
Tensile strength	25 N/cm
Temperature resistance	155°C
Electrical resistance through adhesive*	0.003 Ω

Material 9110: Copper Tape with Non-Conductive Adhesive

Special order only

Base thickness	0.035mm
Total thickness	0.070mm
Adhesive strength	4.5 N/cm
Tensile strength	55 N/cm
Temperature resistance	155°C

Material 9115: Copper Tape with Conductive Adhesive for EMI Shielding, Solderable

Stocked in 13mm & 25mm widths

Base thickness	0.035mm
Total thickness	0.060mm
Adhesive strength	4.5 N/cm
Tensile strength	55 N/cm
Temperature resistance	155°C
Electrical resistance through adhesive*	0.003 Ω

Shielding Effectiveness

20 MHz	100 MHz	500 MHz	1 GHz
62.5 dB	54 dB	55 dB	52.5 dB

Material 9116: Copper Tape with Conductive Adhesive on both sides for EMI Shielding

Special order only

Base thickness	0.035mm
Total thickness	0.085mm
Adhesive strength	4.5 N/cm
Tensile strength	55 N/cm
Temperature resistance	155°C
Electrical resistance through adhesive*	0.003 Ω

Material 9510: Tin-clad Copper Tape with Non-Conductive Adhesive, Solderable

Special order only

Base thickness	0.035mm
Total thickness	0.060mm
Adhesive strength	4.5 N/cm
Tensile strength	40 N/cm

Material 9515: Tin-clad Copper Tape with Conductive Adhesive, Solderable

Special order only

Base thickness	0.035mm
Total thickness	0.060mm
Adhesive strength	4.5 N/cm
Tensile strength	40 N/cm
Temperature resistance	155°C
Electrical resistance through adhesive*	0.003 Ω

Shielding Effectiveness

20 MHz	100 MHz	500 MHz	1 GHz
62.5 dB	58.5 dB	50 dB	61.5 dB

* Electrical resistance tested according to MIL-STD-202F Method 307, across surface area of 25.4mm² conductive foil tape.

Notice

Information supplied in these data sheets is based on independent and laboratory tests which Kemtron believes to be reliable. Kemtron has no control over the design of customer's product which incorporates Kemtron's products, therefore it is the responsibility of the user to determine the suitability for his particular application and we recommend that the user make his own test to determine suitability.

The product described in this data sheet shall be of standard quality, however the products are sold without warranty of fitness for a particular purpose, either expressed or implied, except to the extent expressly stated on Kemtron's invoice, quotation or order acknowledgement. Kemtron does not warrant that products described in this data sheet will be free of conflict with existing or future patents of third parties. All risks of lack of fitness, patent infringement and the like are assumed by the user.